

RD74LVC1G98

Configurable Multiple–Function Gate

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Description

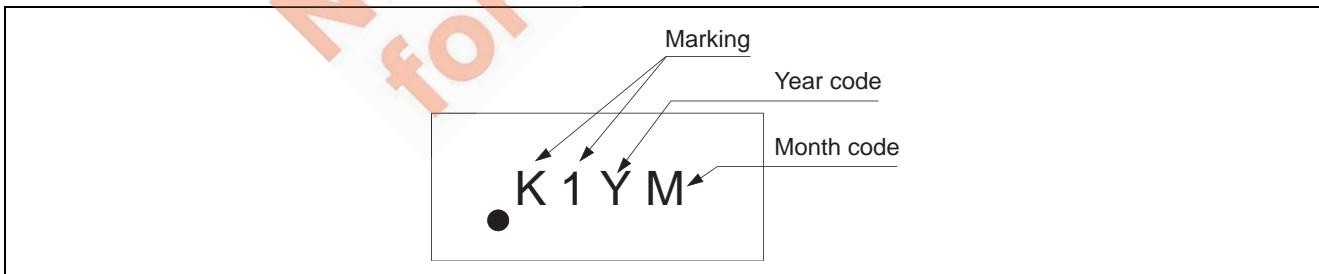
The RD74LVC1G98 has configurable multiple–function gate in a 6-pin package. The Output state is determined by eight patterns of 3-bit input. The user can choose the logic functions AND, NAND, OR, NOR, INVERTER, Non–Inverted Buffer, Data Selector. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- The basic gate function is lined up as Renesas uni logic series.
- Supply voltage range: 1.65 to 5.5 V
- Operating temperature range: -40 to +85°C
- All inputs V_{IH} (Max.) = 5.5 V (@ $V_{CC} = 0$ V to 5.5 V)
- All outputs V_O (Max.) = 5.5 V (@ $V_{CC} = 0$ V)
- Output current:
 - ± 4 mA (@ $V_{CC} = 1.65$ V)
 - ± 8 mA (@ $V_{CC} = 2.3$ V)
 - ± 24 mA (@ $V_{CC} = 3.0$ V)
 - ± 32 mA (@ $V_{CC} = 4.5$ V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
RD74LVC1G98WPE	WCSP-6 pin	SXBG0006LA-A (TBS-6BV)	WP	E (3,000 pcs/reel)

Article Indication



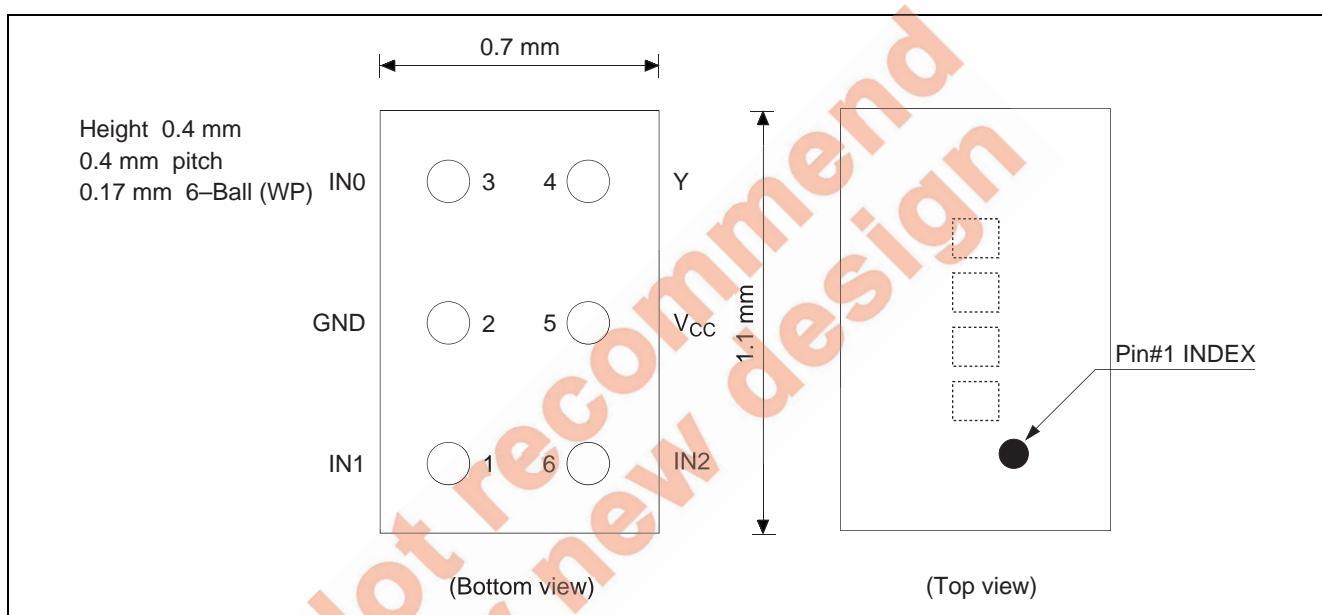
Function Table

Inputs			Output
IN2	IN1	IN0	Y
L	L	L	H
L	L	H	H
L	H	L	L
L	H	H	L
H	L	L	H
H	L	H	L
H	H	L	H
H	H	H	L

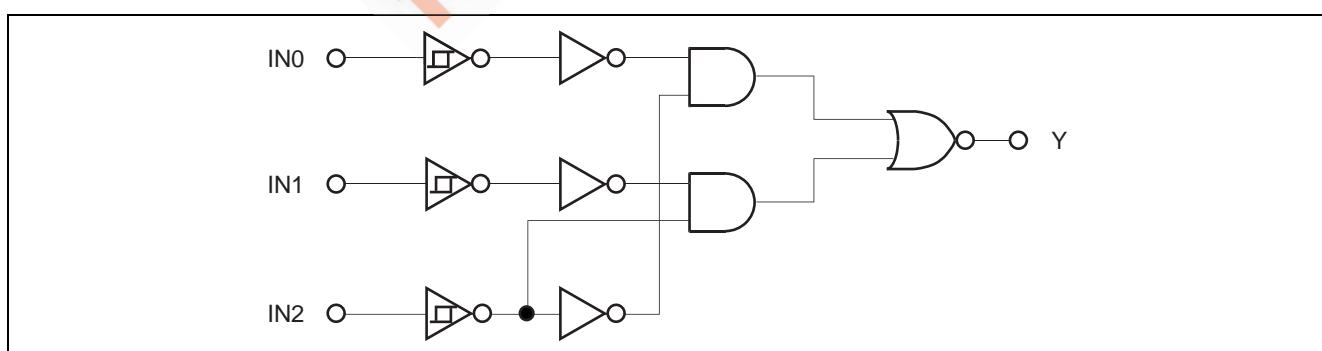
H: High level

L: Low level

Pin Arrangement



Logic Diagram

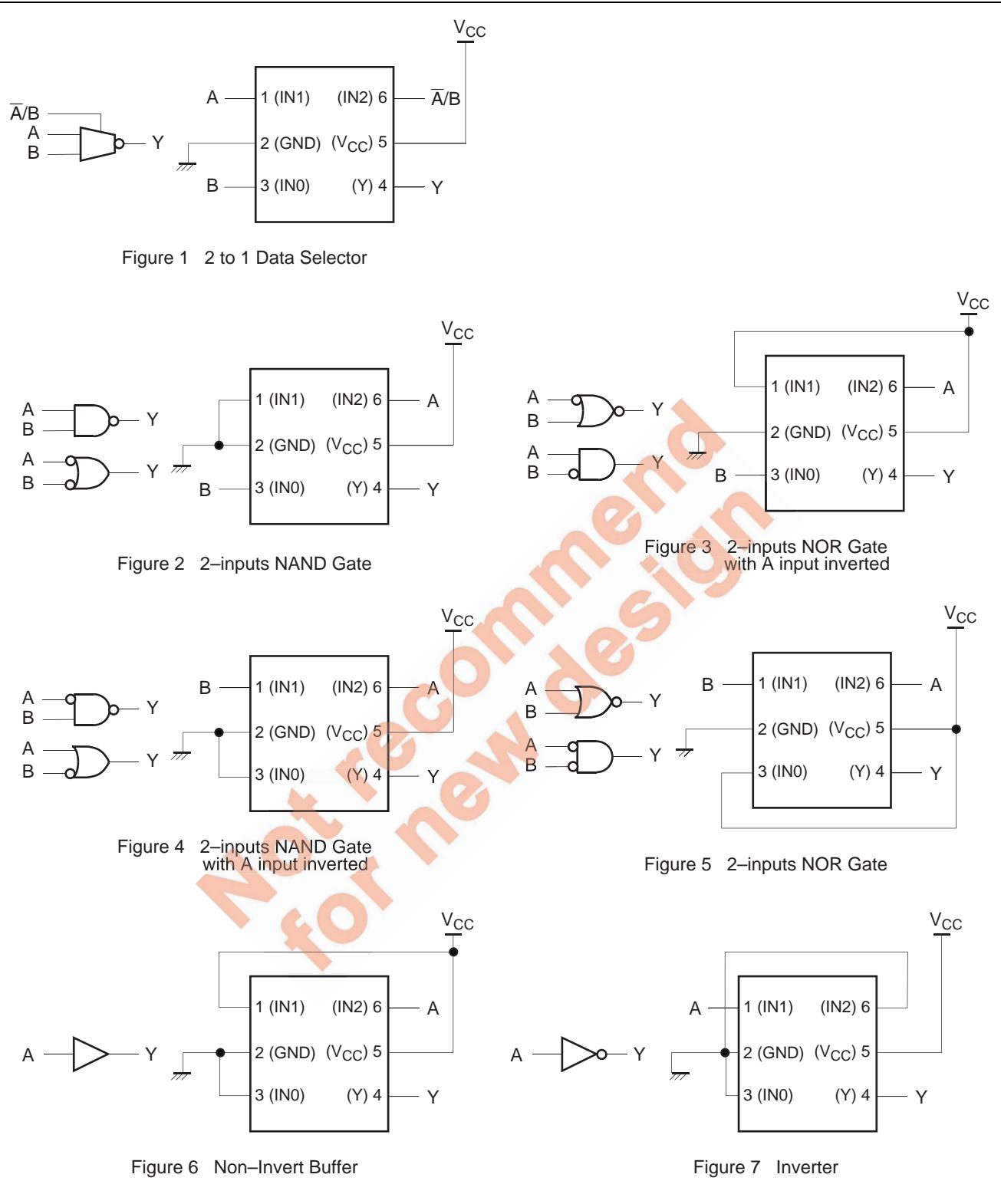


Function Selection Table

Logic Function	Figure No.
2 to 1 data Selector	1
2–inputs NAND	2
2–inputs NOR with one input inverted	3
2–inputs AND with one input inverted	3
2–inputs NAND with one input inverted	4
2–inputs OR with one input inverted	4
2–inputs NOR	5
Non-Invert Buffer	6
Inverter	7

Not recommended
for new design

Logic Configurations



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V_{CC}	-0.5 to 6.5	V	
Input voltage range ^{*1}	V_I	-0.5 to 6.5	V	
Output voltage range ^{*1, 2}	V_O	-0.5 to $V_{CC} + 0.5$	V	Output : H or L
		-0.5 to 6.5		V_{CC} : OFF
Input clamp current	I_{IK}	-50	mA	$V_I < 0$
Output clamp current	I_{OK}	-50	mA	$V_O < 0$
Continuous output current	I_O	± 50	mA	$V_O = 0$ to V_{CC}
Continuous current through V_{CC} or GND	I_{CC} or I_{GND}	± 100	mA	
Package Thermal impedance	θ_{ja}	123	°C/W	WP
Storage temperature	T_{STG}	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This value is limited to 5.5 V maximum.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V_{CC}	1.65	5.5	V	
Input voltage range	V_I	0	5.5	V	
Output voltage range	V_O	0	V_{CC}	V	
Output current	I_{OL}	—	4	mA	$V_{CC} = 1.65$ V
		—	8		$V_{CC} = 2.3$ V
		—	16		$V_{CC} = 3.0$ V
		—	24		$V_{CC} = 4.5$ V
		—	32		$V_{CC} = 1.65$ V
	I_{OH}	—	-4		$V_{CC} = 2.3$ V
		—	-8		$V_{CC} = 3.0$ V
		—	-16		$V_{CC} = 4.5$ V
		—	-24		
		—	-32		
Operating free-air temperature	T_a	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristics

Ta = -40 to 85°C

Item	Symbol	V _{CC} (V)	Min	Typ	Max	Unit	Test condition
Threshold voltage	V _T ⁺	1.8	0.8	—	1.4	V	
		2.5	1.2	—	1.7		
		3.3	1.6	—	2.3		
		5.0	2.3	—	3.0		
	V _T ⁻	1.8	0.4	—	0.7		
		2.5	0.6	—	1.0		
		3.3	0.9	—	1.4		
		5.0	1.5	—	2.0		
	ΔV_T	1.8	0.4	—	0.7		
		2.5	0.4	—	0.8		
		3.3	0.4	—	0.9		
		5.0	0.4	—	1.0		
Output voltage	V _{OH}	1.65 to 5.5	V _{CC} -0.1	—	—	V	I _{OH} = -100 µA
		1.65	1.2	—	—		I _{OH} = -4 mA
		2.3	1.9	—	—		I _{OH} = -8 mA
		3.0	2.4	—	—		I _{OH} = -16 mA
			2.3	—	—		I _{OH} = -24 mA
		4.5	3.8	—	—		I _{OH} = -32 mA
	V _{OL}	1.65 to 5.5	—	—	0.1		I _{OL} = 100 µA
		1.65	—	—	0.45		I _{OL} = 4 mA
		2.3	—	—	0.3		I _{OL} = 8 mA
		3.0	—	—	0.4		I _{OL} = 16 mA
			—	—	0.55		I _{OL} = 24 mA
		4.5	—	—	0.55		I _{OL} = 32 mA
Input current	I _{IN}	0 to 5.5	—	—	±5	µA	V _{IN} = 5.5 V or GND
Quiescent supply current	I _{CC}	5.5	—	—	10	µA	V _{IN} = V _{CC} or GND, I _O = 0
	ΔI _{CC}	3 to 5.5	—	—	500		One input at V _{CC} -0.6 V, Other input at V _{CC} or GND
Output leakage current	I _{OFF}	0	—	—	±10	µA	V _{IN} or V _O = 0 to 5.5 V
Input capacitance	C _{IN}	3.3	—	3.5	—	pF	V _{IN} = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

$V_{CC} = 1.8 \pm 0.15$ V

Item	Symbol	Ta = -40 to 85°C		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Max				
Propagation delay time	t_{PLH} t_{PHL}	3.2	14.4	ns	$C_L = 30$ pF, $R_L = 1.0$ kΩ	IN	Y

$V_{CC} = 2.5 \pm 0.2$ V

Item	Symbol	Ta = -40 to 85°C		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Max				
Propagation delay time	t_{PLH} t_{PHL}	2.0	8.3	ns	$C_L = 30$ pF, $R_L = 500$ Ω	IN	Y

$V_{CC} = 3.3 \pm 0.3$ V

Item	Symbol	Ta = -40 to 85°C		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Max				
Propagation delay time	t_{PLH} t_{PHL}	1.5	6.3	ns	$C_L = 50$ pF, $R_L = 500$ Ω	IN	Y

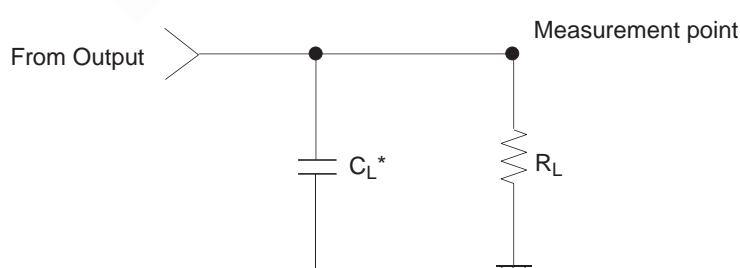
$V_{CC} = 5.0 \pm 0.5$ V

Item	Symbol	Ta = -40 to 85°C		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Max				
Propagation delay time	t_{PLH} t_{PHL}	1.1	5.1	ns	$C_L = 50$ pF, $R_L = 500$ Ω	IN	Y

Operating Characteristics

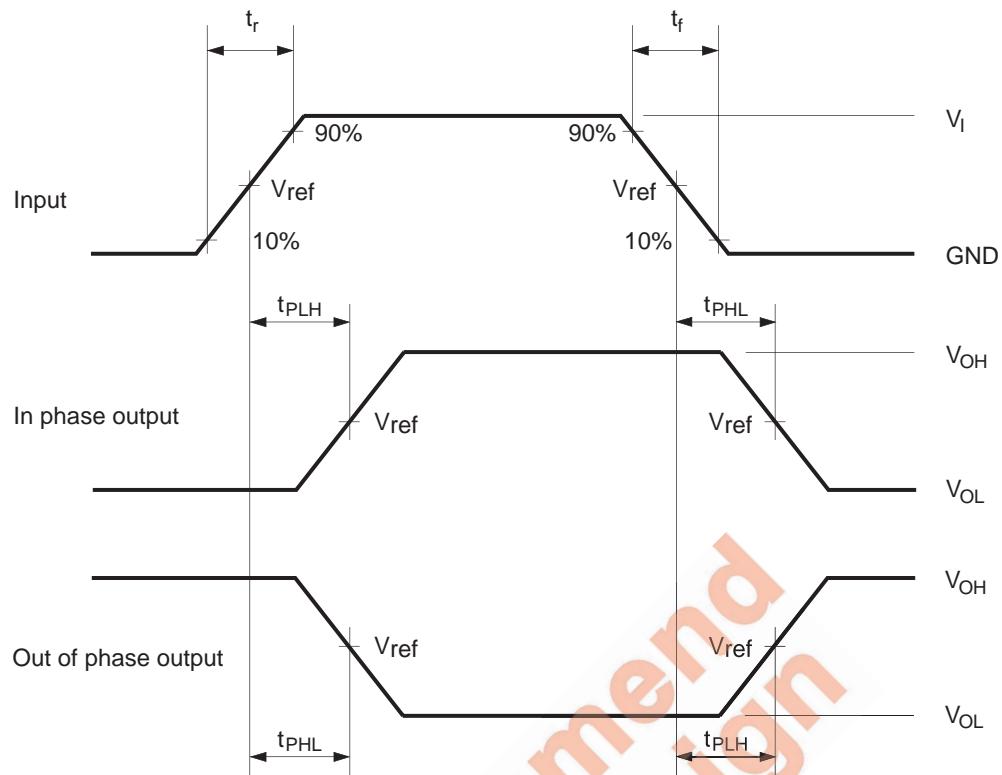
Item	Symbol	V _{CC} (V)	Ta = 25°C			Unit	Test Conditions
			Min	Typ	Max		
Power dissipation capacitance	C _{PD}	1.8	—	23	—	pF	f = 10 MHz
		2.5	—	23	—		
		3.3	—	23	—		
		5.0	—	26	—		

Test Circuit



Note: C_L includes probe and jig capacitance.

- Waveforms



V_{CC} (V)	Inputs		V_{ref}	C_L	R_L
	V_I	t_r / t_f			
1.8 ± 0.15	V_{CC}	≤ 2 ns	$V_{CC} / 2$	30 pF	$1.0 \text{ k}\Omega$
2.5 ± 0.2	V_{CC}	≤ 2 ns	$V_{CC} / 2$	30 pF	500Ω
3.3 ± 0.3	3 V	≤ 2.5 ns	1.5 V	50 pF	500Ω
5.0 ± 0.5	V_{CC}	≤ 2.5 ns	$V_{CC} / 2$	50 pF	500Ω

Notes: 1. Input waveform : PRR ≤ 10 MHz, $Z_o = 50 \Omega$.
 2. The output are measured one at a time with one transition per measurement.

Package Dimensions

JEITA Package Code	RENESAS Code	Previous Code	MASS(Typ.)
S-XFBGA6-0.7x1.1-0.40	SXBG0006LA-A	TBS-6BV	0.001g

*Reference value.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	—	—	0.40
A ₁	0.110	—	0.140
A ₂	—	—	(0.235) [*]
b	0.15	—	0.19
D	—	0.70	—
E	—	1.10	—
e	—	0.40	—
x	—	—	0.05
y	—	—	0.05
Z _D	—	0.15	—
Z _E	—	0.15	—

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Renesas Technology America, Inc.

450 Holger Way, San Jose, CA 95134-1368, U.S.A
Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited

Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology (Shanghai) Co., Ltd.

Unit 204, 205, AZIACenter, No.1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120
Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7898

Renesas Technology Hong Kong Ltd.

7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong
Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd.

10th Floor, No.99, Fushing North Road, Taipei, Taiwan
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology Singapore Pte. Ltd.

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd.

Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea
Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd.

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: <603> 7955-9390, Fax: <603> 7955-9510